MOSFET – N-Channel, SUPERFET II, FRFET

600 V, 37 A, 104 m Ω

FCH104N60F

Description

SUPERFET[®] II MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SUPERFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications. SUPERFET II FRFET[®] MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.

Features

- $650 \text{ V} @ \text{T}_{\text{J}} = 150^{\circ}\text{C}$
- Typ. $R_{DS(on)} = 98 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 107 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 109 pF)
- 100% Avalanche Tested
- This Device is Pb-Free and is RoHS Compliant

Applications

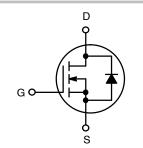
- Telecom / Server Power Supplies
- Industrial Power Supplies
- EV Charger
- UPS / Solar



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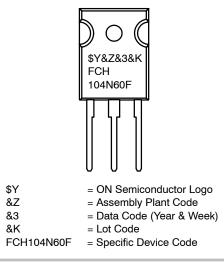
V _{DSS}	V _{DSS} R _{DS(ON)} MAX	
600 V	104 m Ω	37 A



N-Channel MOSFET



MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter	FCH104N60F	Unit	
V _{DSS}	Drain to Source Voltage		600	V
V _{GSS}	Gate to Source Voltage	DC	±20	V
		AC (f > 1 Hz)	±30	
I _D	Drain Current	Continuous (T _C = 25°C)	37	A
		Continuous (T _C = 100°C)	24	
I _{DM}	Drain Current	Pulsed (Note 1)	111	A
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		809	mJ
I _{AR}	Avalanche Current (Note 1)	6.8	A	
E _{AR}	Repetitive Avalanche Energy (Note 1)	3.57	mJ	
dv/dt	MOSFET dv/dt Peak Diode Recovery dv/dt (Note 3)		100	V/ns
			50	1
PD	Power Dissipation	(T _C = 25°C)	357	W
		Derate Above 25°C	2.85	W/°C
T _J , T _{STG}	J, T _{STG} Operating and Storage Temperature Range		–55 to +150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 s		300	°C

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 6.8 \text{ A}, R_G = 25 \Omega$, starting $T_J = 25^{\circ}C$. 3. $I_{SD} \le 18.5 \text{ A}, \text{ di/dt} \le 200 \text{ A/}\mu\text{s}, V_{DD} \le 380 \text{ V}, \text{ starting } T_J = 25^{\circ}C$.

THERMAL CHARACTERISTICS

Symbol	Parameter	FCH104N60F	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.35	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	40	

PACKAGE MARKING AND ORDERING INFORMATION

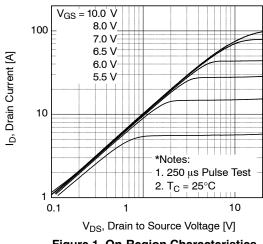
Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity	
FCH104N60F	FCH104N60F	TO-247	Tube	N/A	N/A	30 Units	

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACT	ERISTICS	-				
BV _{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_D = 10 mA, T_J = 25°C	600	-	-	V
		V_{GS} = 0 V, I _D = 10 mA, T _J = 150°C	650	-	-	
$\Delta \text{BV}_{\text{DSS}}\!/\!\Delta\text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 10$ mA, Referenced to $25^{\circ}C$	_	0.67	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	_	-	10	μA
		V_{DS} = 480 V, V_{GS} = 0 V, T_{C} = 125°C	-	16	-	
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 20$ V, $V_{DS} = 0$ V	-	-	±100	nA
ON CHARACTE	RISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$	3	-	5	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 18.5 A	-	98	104	mΩ
9fs	Forward Transconductance	V _{DS} = 20 V, I _D = 18.5 A	-	47	_	S
	RACTERISTICS	•				
C _{iss}	Input Capacitance	V _{DS} = 100 V, V _{GS} = 0 V, f = 1 MHz	-	4475	5950	pF
C _{oss}	Output Capacitance		-	135	180	pF
C _{rss}	Reverse Transfer Capacitance		-	1.5	2.5	pF
Coss	Output Capacitance	V _{DS} = 380 V, V _{GS} = 0 V, f = 1 MHz	-	75	-	pF
C _{oss(eff.)}	Effective Output Capacitance	$V_{DS} = 0 \text{ V}$ to 480 V, $V_{GS} = 0 \text{ V}$	-	109	-	pF
Q _{g(tot)}	Total Gate Charge at 10 V	V_{DS} = 380 V, I _D = 18.5 A, V _{GS} = 10 V	-	107	139	nC
Q _{gs}	Gate to Source Gate Charge	(Note 4)	-	25	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	44	-	nC
ESR	Equivalent Series Resistance (G-S)	f = 1 MHz	-	0.87	-	Ω
WITCHING CH	IARACTERISTICS	•			•	
t _{d(on)}	Turn-On Delay Time	V _{DD} = 380 V, I _D = 18.5 A,	-	34	78	ns
t _r	Turn-On Rise Time	V _{GS} = 10 V, R _G = 4.7 Ω (Note 4)	-	24	58	ns
t _{d(off)}	Turn-Off Delay Time		-	98	206	ns
t _f	Turn-Off Fall Time		-	5	20	ns
OURCE-DRAII	N DIODE CHARACTERISTICS			•		
۱ _S	Maximum Continuous Source to Drain Diode Forward Current			_	37	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current			-	111	Α
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 18.5 A		-	1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 18.5,	-	144	-	ns
Q _{rr}	Reverse Recovery Charge	dl _F /dt = 100 Å/μs		0.91	_	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS





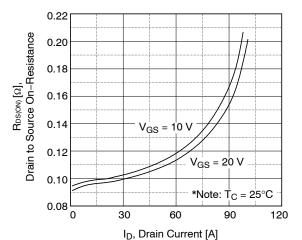
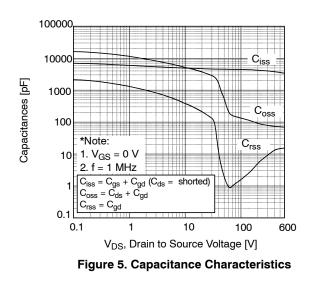


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage



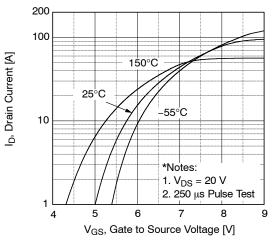


Figure 2. Transfer Characteristics

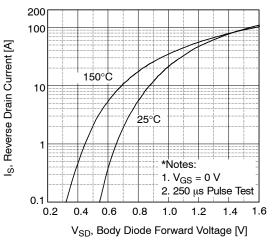
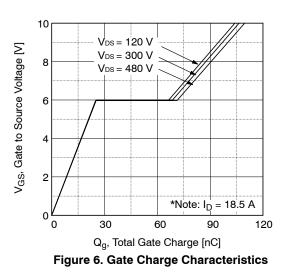
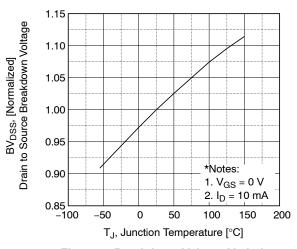
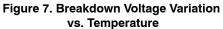


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature



TYPICAL PERFORMANCE CHARACTERISTICS (continued)





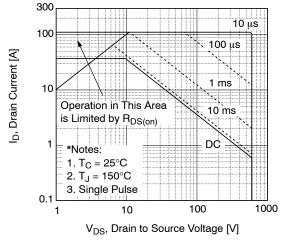
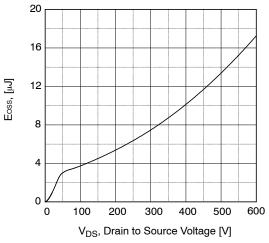


Figure 9. Maximum Safe Operation Area





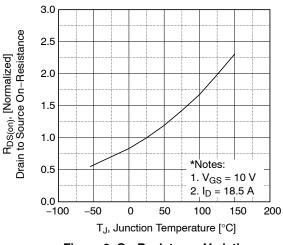
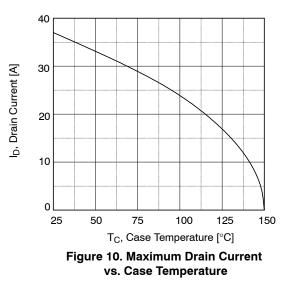


Figure 8. On-Resistance Variation vs. Temperature



TYPICAL PERFORMANCE CHARACTERISTICS (continued)

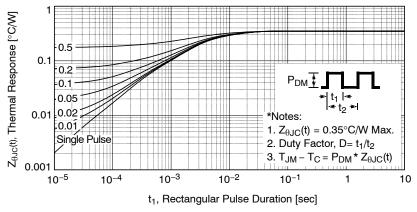


Figure 12. Transient Thermal Response Curve

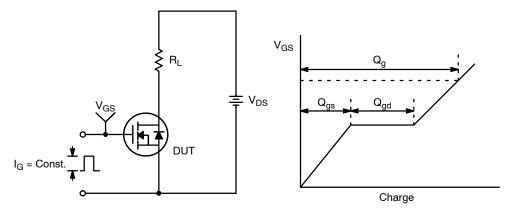


Figure 13. Gate Charge Test Circuit & Waveform

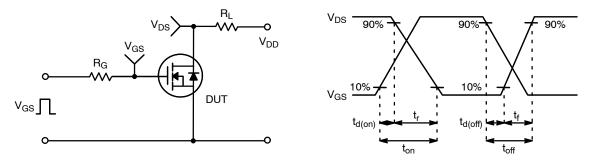


Figure 14. Resistive Switching Test Circuit & Waveforms

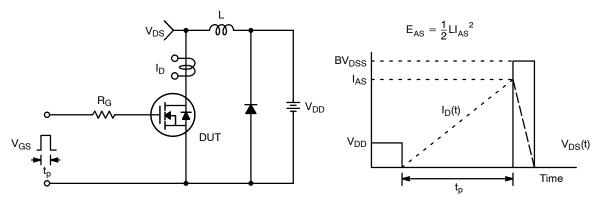


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

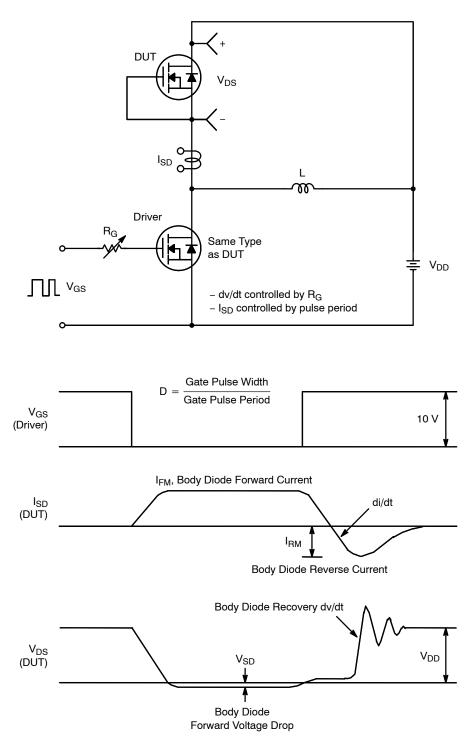
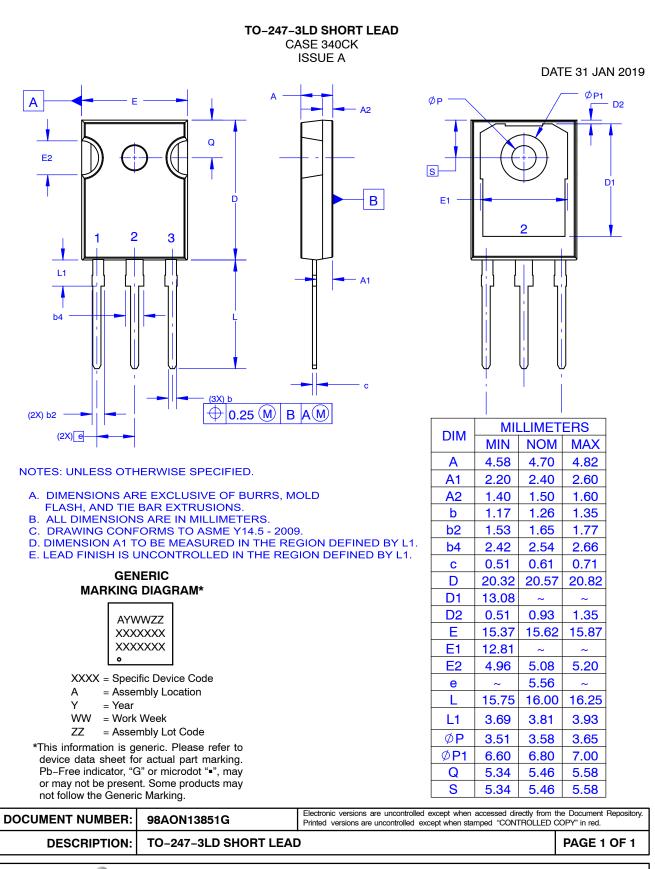


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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